

FEATURES

- Member of the Texas Instruments Widebus™ Family
- Operates From 1.65 V to 3.6 V
- Max t_{pd} of 4 ns at 3.3 V
- ± 12 -mA Output Drive at 3.3 V
- Output Port Has Equivalent 26- Ω Series Resistors, So No External Resistors Are Required
- Designed to Comply With JEDEC 168-Pin and 200-Pin SDRAM Buffered DIMM Specification
- Latch-Up Performance Exceeds 250 mA Per JESD 17
- ESD Protection Exceeds JESD 22
 - 2000-V Human-Body Model (A114-A)
 - 200-V Machine Model (A115-A)
 - 1000-V Charged-Device Model (C101)

DESCRIPTION/ORDERING INFORMATION

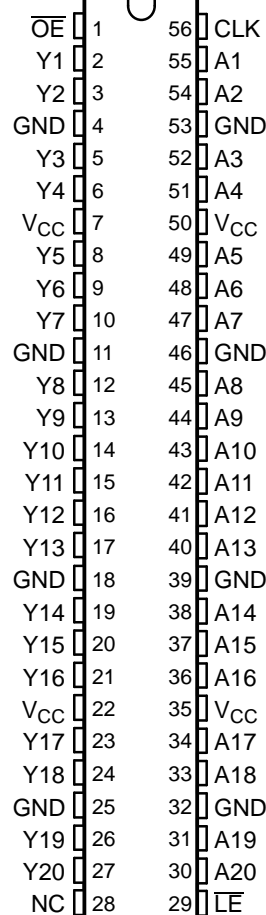
This 20-bit universal bus driver is designed for 1.65-V to 3.6-V V_{CC} operation.

Data flow from A to Y is controlled by the output-enable (\overline{OE}) input. The device operates in the transparent mode when the latch-enable (\overline{LE}) input is low. When \overline{LE} is high, the A data is latched if the clock (CLK) input is held at a high or low logic level. If \overline{LE} is high, the A data is stored in the latch/flip-flop on the low-to-high transition of CLK. When \overline{OE} is high, the outputs are in the high-impedance state.

The output port includes equivalent 26- Ω series resistors to reduce overshoot and undershoot.

To ensure the high-impedance state during power up or power down, \overline{OE} should be tied to V_{CC} through a pullup resistor; the minimum value of the resistor is determined by the current-sinking capability of the driver.

DGG, DGV, OR DL PACKAGE
(TOP VIEW)



NC – No internal connection

ORDERING INFORMATION

T_A	PACKAGE ⁽¹⁾		ORDERABLE PART NUMBER	TOP-SIDE MARKING
-40°C to 85°C	SSOP - DL	Tube	SN74ALVC162836DL	ALVC162836
		Tape and reel	SN74ALVC162836DLR	
	TSSOP - DGG	Tape and reel	SN74ALVC162836DGGR	ALVC162836
	TVSOP - DGV	Tape and reel	SN74ALVC162836DGVR	VC2836

(1) Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at www.ti.com/sc/package.



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SN74ALVC162836 20-BIT UNIVERSAL BUS DRIVER WITH 3-STATE OUTPUTS

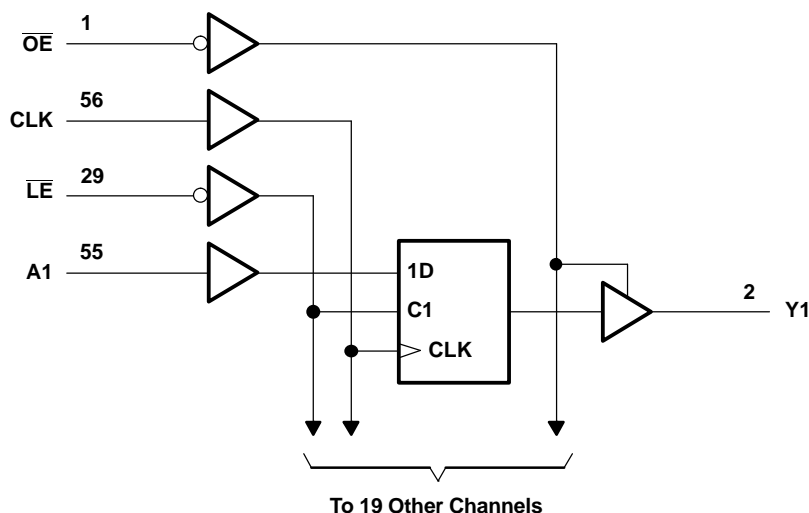
SCES129D—MARCH 1998—REVISED AUGUST 2004

FUNCTION TABLE

INPUTS				OUTPUT Y
\overline{OE}	\overline{LE}	CLK	A	
H	X	X	X	Z
L	L	X	L	L
L	L	X	H	H
L	H	↑	L	L
L	H	↑	H	H
L	H	L or H	X	$Y_0^{(1)}$

(1) Output level before the indicated steady-state input conditions were established

LOGIC DIAGRAM (POSITIVE LOGIC)



ABSOLUTE MAXIMUM RATINGS⁽¹⁾

over operating free-air temperature range (unless otherwise noted)

		MIN	MAX	UNIT
V_{CC}	Supply voltage range	-0.5	4.6	V
V_I	Input voltage range ⁽²⁾	-0.5	4.6	V
V_O	Output voltage range ⁽²⁾⁽³⁾	-0.5	$V_{CC} + 0.5$	V
I_{IK}	Input clamp current	$V_I < 0$		-50 mA
I_{OK}	Output clamp current	$V_O < 0$		-50 mA
I_O	Continuous output current			±50 mA
Continuous current through each V_{CC} or GND				±100 mA
θ_{JA}	Package thermal impedance ⁽⁴⁾	DGG package		64
		DGV package		48
		DL package		56
T_{stg}	Storage temperature range	-65	150	°C

(1) Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

(2) The input negative-voltage and output voltage ratings may be exceeded if the input and output current ratings are observed.

(3) This value is limited to 4.6 V maximum.

(4) The package thermal impedance is calculated in accordance with JESD 51-7.

RECOMMENDED OPERATING CONDITIONS⁽¹⁾

		MIN	MAX	UNIT
V_{CC}	Supply voltage	1.65	3.6	V
V_{IH}	High-level input voltage	$V_{CC} = 1.65\text{ V to }1.95\text{ V}$	$0.65 \times V_{CC}$	V
		$V_{CC} = 2.3\text{ V to }2.7\text{ V}$	1.7	
		$V_{CC} = 2.7\text{ V to }3.6\text{ V}$	2	
V_{IL}	Low-level input voltage	$V_{CC} = 1.65\text{ V to }1.95\text{ V}$	$0.35 \times V_{CC}$	V
		$V_{CC} = 2.3\text{ V to }2.7\text{ V}$	0.7	
		$V_{CC} = 2.7\text{ V to }3.6\text{ V}$	0.8	
V_I	Input voltage	0	3.6	V
V_O	Output voltage	0	V_{CC}	V
I_{OH}	High-level output current	$V_{CC} = 1.65\text{ V}$	-2	mA
		$V_{CC} = 2.3\text{ V}$	-6	
		$V_{CC} = 2.7\text{ V}$	-8	
		$V_{CC} = 3\text{ V}$	-12	
I_{OL}	Low-level output current	$V_{CC} = 1.65\text{ V}$	2	mA
		$V_{CC} = 2.3\text{ V}$	6	
		$V_{CC} = 2.7\text{ V}$	8	
		$V_{CC} = 3\text{ V}$	12	
$\Delta t/\Delta v$	Input transition rise or fall rate		10	ns/V
T_A	Operating free-air temperature	-40	85	°C

(1) All unused inputs of the device must be held at V_{CC} or GND to ensure proper device operation. Refer to the TI application report, *Implications of Slow or Floating CMOS Inputs*, literature number SCBA004.

ELECTRICAL CHARACTERISTICS

over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER	TEST CONDITIONS	V_{CC}	MIN	TYP ⁽¹⁾	MAX	UNIT
V_{OH}	$I_{OH} = -100\ \mu\text{A}$	1.65 V to 3.6 V	$V_{CC} - 0.2$			V
	$I_{OH} = -2\ \text{mA}$	1.65 V	1.2			
	$I_{OH} = -4\ \text{mA}$	2.3 V	1.9			
	$I_{OH} = -6\ \text{mA}$	2.3 V	1.7			
		3 V	2.4			
	$I_{OH} = -8\ \text{mA}$	2.7 V	2			
	$I_{OH} = -12\ \text{mA}$	3 V	2			
V_{OL}	$I_{OL} = 100\ \mu\text{A}$	1.65 V to 3.6 V			0.2	V
	$I_{OL} = 2\ \text{mA}$	1.65 V			0.45	
	$I_{OL} = 4\ \text{mA}$	2.3 V			0.4	
	$I_{OL} = 6\ \text{mA}$	2.3 V			0.55	
		3 V			0.55	
	$I_{OL} = 8\ \text{mA}$	2.7 V			0.6	
	$I_{OL} = 12\ \text{mA}$	3 V			0.8	
I_I	$V_I = V_{CC}$ or GND	3.6 V			± 5	μA
I_{OZ}	$V_O = V_{CC}$ or GND	3.6 V			± 10	μA
I_{CC}	$V_I = V_{CC}$ or GND, $I_O = 0$	3.6 V			40	μA
ΔI_{CC}	One input at $V_{CC} - 0.6\text{ V}$, Other inputs at V_{CC} or GND	3 V to 3.6 V			750	μA
C_i	Control inputs	$V_I = V_{CC}$ or GND	3.3 V	5		pF
	Data inputs			5.5		
C_o	Outputs	$V_O = V_{CC}$ or GND	3.3 V	7.5		pF

(1) All typical values are at $V_{CC} = 3.3\text{ V}$, $T_A = 25^\circ\text{C}$.

SN74ALVC162836

20-BIT UNIVERSAL BUS DRIVER WITH 3-STATE OUTPUTS

SCES129D–MARCH 1998–REVISED AUGUST 2004

TIMING REQUIREMENTS

over recommended operating free-air temperature range (unless otherwise noted) (see Figure 1)

		$V_{CC} = 1.8\text{ V}$		$V_{CC} = 2.5\text{ V} \pm 0.2\text{ V}$		$V_{CC} = 2.7\text{ V}$		$V_{CC} = 3.3\text{ V} \pm 0.3\text{ V}$		UNIT	
		MIN	MAX	MIN	MAX	MIN	MAX	MIN	MAX		
f_{clock}	Clock frequency	(1)		150		150		150		MHz	
t_w	Pulse duration	$\overline{\text{LE}}$ low		(1)		3.3		3.3		ns	
		CLK high or low		(1)		3.3		3.3			
t_{su}	Setup time	Data before CLK \uparrow		(1)		1.4		1.5		ns	
		Data before $\overline{\text{LE}}\uparrow$	CLK high		(1)		1.2		1.3		
			CLK low		(1)		1.4		1.2		
t_h	Hold time	Data after CLK \uparrow		(1)		0.9		0.9		ns	
		Data after $\overline{\text{LE}}\uparrow$	CLK high or low		(1)		1.1		1.1		

(1) This information was not available at the time of publication.

SWITCHING CHARACTERISTICS

over recommended operating free-air temperature range (unless otherwise noted) (see Figure 1)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	$V_{CC} = 1.8\text{ V}$		$V_{CC} = 2.5\text{ V} \pm 0.2\text{ V}$		$V_{CC} = 2.7\text{ V}$		$V_{CC} = 3.3\text{ V} \pm 0.3\text{ V}$		UNIT
			MIN	MAX	MIN	MAX	MIN	MAX	MIN	MAX	
f_{max}			(1)		150		150		150		MHz
t_{pd}	A	Y	(1)		1	4.4	4.6		1.2	4	ns
	$\overline{\text{LE}}$		(1)		1.1	5.8	6.1		1.4	5.1	
	CLK		(1)		1	5.2	5.5		1.1	5	
t_{en}	$\overline{\text{OE}}$	Y	(1)		1.1	6.4	6.5		1.2	5.5	ns
t_{dis}	$\overline{\text{OE}}$	Y	(1)		1	4.7	5.2		1.7	5.1	ns

(1) This information was not available at the time of publication.

SWITCHING CHARACTERISTICS

from 0°C to 65°C, $C_L = 50\text{ pF}$

PARAMETER	FROM (INPUT)	TO (OUTPUT)	$V_{CC} = 3.3\text{ V} \pm 0.15\text{ V}$		UNIT
			MIN	MAX	
t_{pd}	A	Y	1	4	ns
	CLK		1.7	4.5	

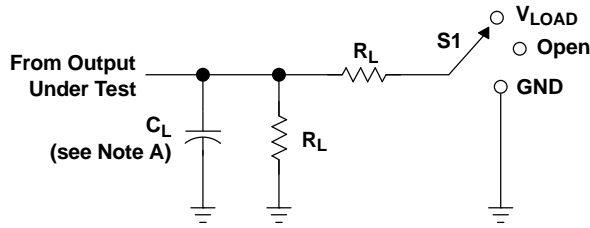
OPERATING CHARACTERISTICS

$T_A = 25^\circ\text{C}$

PARAMETER		TEST CONDITIONS	$V_{CC} = 1.8\text{ V}$	$V_{CC} = 2.5\text{ V}$	$V_{CC} = 3.3\text{ V}$	UNIT
			TYP	TYP	TYP	
C_{pd}	Outputs enabled	$C_L = 0\text{ pF}, f = 10\text{ MHz}$	(1)	31	36	pF
	Outputs disabled		(1)	7	11	

(1) This information was not available at the time of publication.

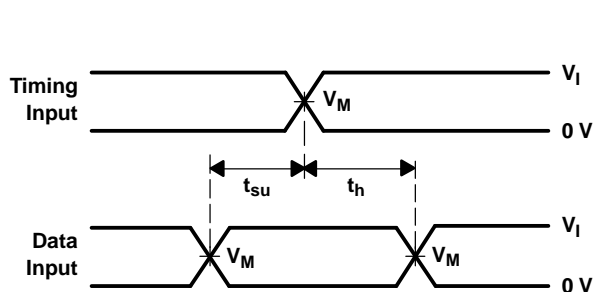
PARAMETER MEASUREMENT INFORMATION



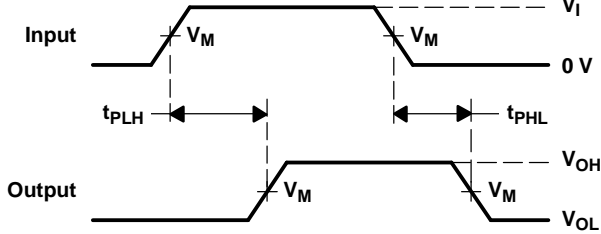
LOAD CIRCUIT

TEST	S1
t_{pd}	Open
t_{PLZ}/t_{PZL}	V_{LOAD}
t_{PHZ}/t_{PZH}	GND

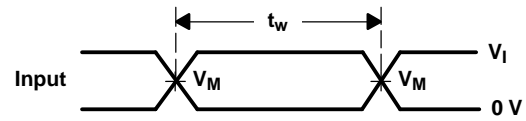
V_{CC}	INPUT		V_M	V_{LOAD}	C_L	R_L	V_{Δ}
	V_I	t_r/t_f					
1.8 V	V_{CC}	≤ 2 ns	$V_{CC}/2$	$2 \times V_{CC}$	30 pF	1 k Ω	0.15 V
2.5 V \pm 0.2 V	V_{CC}	≤ 2 ns	$V_{CC}/2$	$2 \times V_{CC}$	30 pF	500 Ω	0.15 V
2.7 V	2.7 V	≤ 2.5 ns	1.5 V	6 V	50 pF	500 Ω	0.3 V
3.3 V \pm 0.3 V	2.7 V	≤ 2.5 ns	1.5 V	6 V	50 pF	500 Ω	0.3 V



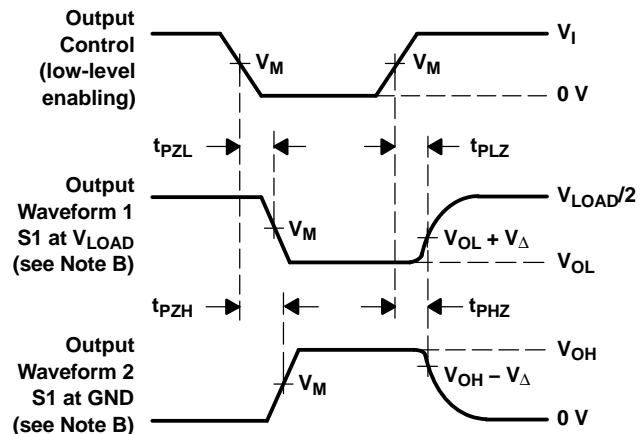
VOLTAGE WAVEFORMS
SETUP AND HOLD TIMES



VOLTAGE WAVEFORMS
PROPAGATION DELAY TIMES



VOLTAGE WAVEFORMS
PULSE DURATION



VOLTAGE WAVEFORMS
ENABLE AND DISABLE TIMES

- NOTES: A. C_L includes probe and jig capacitance.
 B. Waveform 1 is for an output with internal conditions such that the output is low, except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high, except when disabled by the output control.
 C. All input pulses are supplied by generators having the following characteristics: PRR \leq 10 MHz, $Z_O = 50 \Omega$.
 D. The outputs are measured one at a time, with one transition per measurement.
 E. t_{PLZ} and t_{PHZ} are the same as t_{dis} .
 F. t_{PZL} and t_{PZH} are the same as t_{en} .
 G. t_{PLH} and t_{PHL} are the same as t_{pd} .
 H. All parameters and waveforms are not applicable to all devices.

Figure 1. Load Circuit and Voltage Waveforms

DGV (R-PDSO-G**)

PLASTIC SMALL-OUTLINE

24 PINS SHOWN

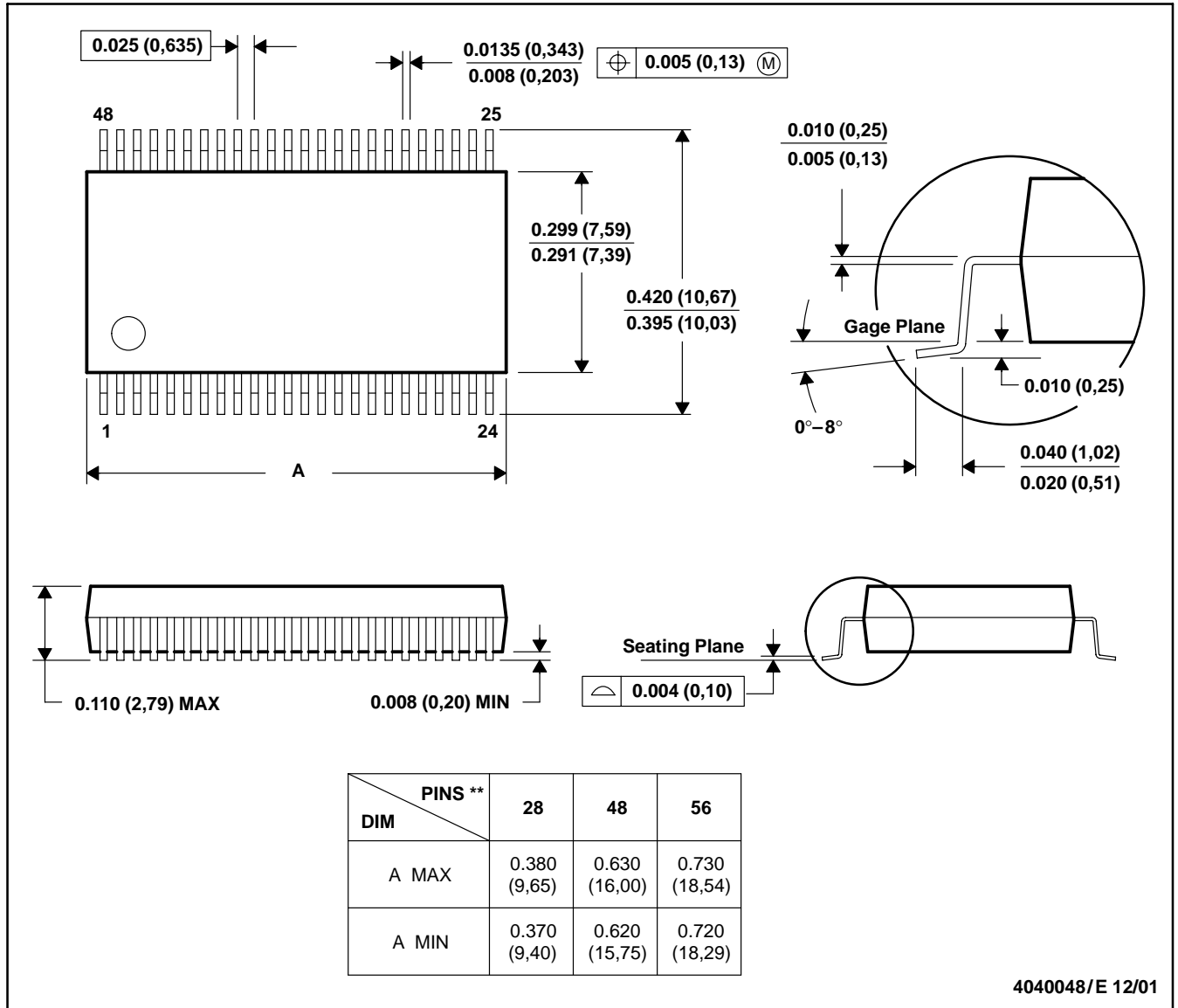


- NOTES: A. All linear dimensions are in millimeters.
 B. This drawing is subject to change without notice.
 C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15 per side.
 D. Falls within JEDEC: 24/48 Pins – MO-153
 14/16/20/56 Pins – MO-194

DL (R-PDSO-G**)

PLASTIC SMALL-OUTLINE PACKAGE

48 PINS SHOWN

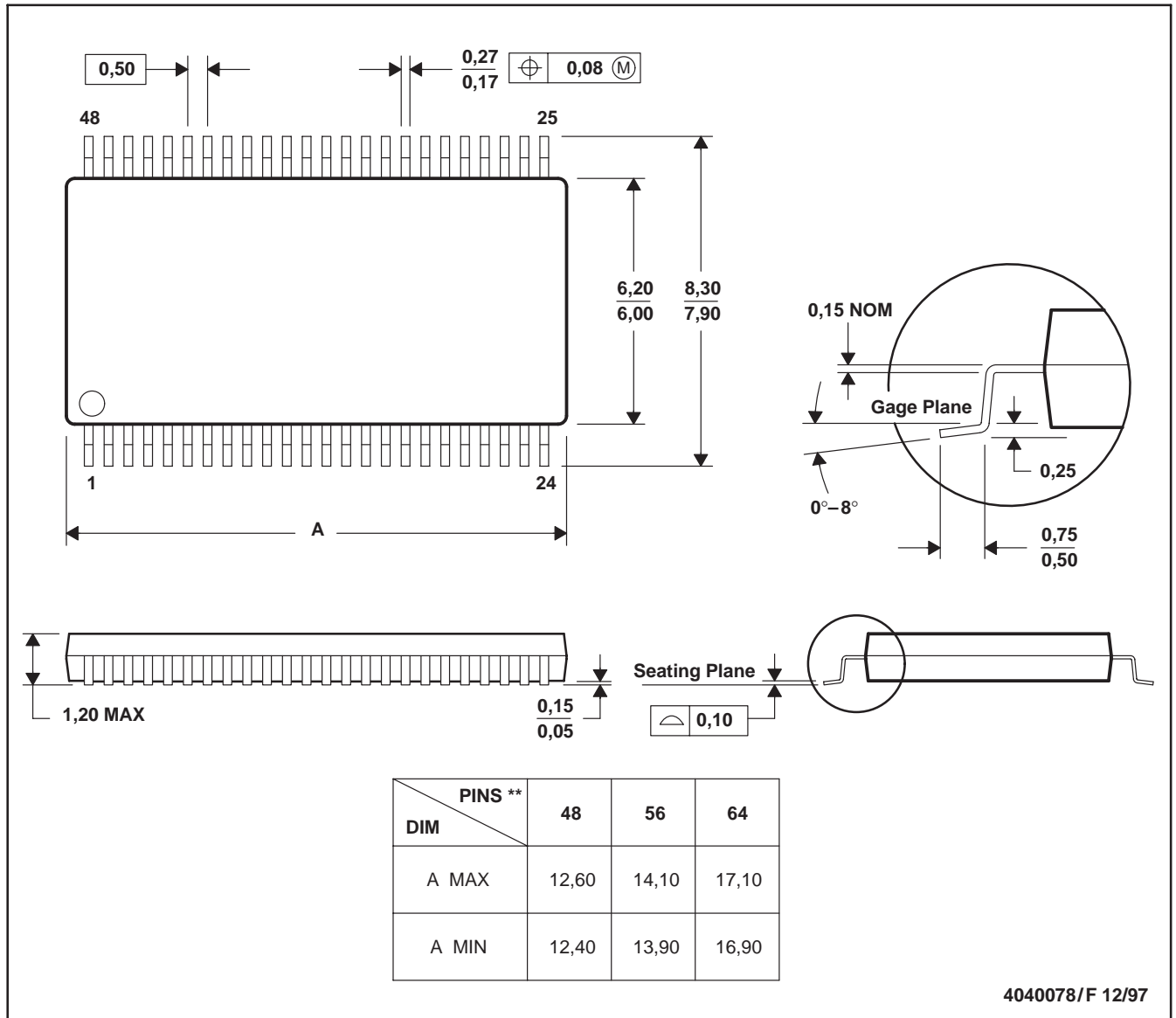


- NOTES: A. All linear dimensions are in inches (millimeters).
 B. This drawing is subject to change without notice.
 C. Body dimensions do not include mold flash or protrusion not to exceed 0.006 (0,15).
 D. Falls within JEDEC MO-118

DGG (R-PDSO-G**)

PLASTIC SMALL-OUTLINE PACKAGE

48 PINS SHOWN



- NOTES: A. All linear dimensions are in millimeters.
 B. This drawing is subject to change without notice.
 C. Body dimensions do not include mold protrusion not to exceed 0,15.
 D. Falls within JEDEC MO-153

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Mailing Address: Texas Instruments
Post Office Box 655303 Dallas, Texas 75265